ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INFORMATION	PC, Bannockł	ourn, Illinois. A	Il rights reserved untions.	nder both	This docum level parts,	ent is a declaration entite decl	on of the substancompasses all	ances within the manufact lower level materials for	turer listed which the	item. Note: i manufacturer	f the item is an as r has engineering	sembly with lower responsibility.	
	21.1 IPC Web Site for Information on IPC-1752 Standard Form 7 http://www.ipc.org/IPC-175x Distrib				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mf					Mfg Informati	ion		
Supplier Information													
Company name* Com		Company un	Company unique ID			Unique ID Authority				Response Date*			
onsemi							202			2025-06-04			
Contact Name Title - Contact			ct	Phone - Contact*				Email	Email - Contact*				
Product-Env-Stewards Product Envi			nviro Compliance		NA			Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			resentative		Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards Produ			Product Enviro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	r Mfr Item Number		r Mfr Item Name			Effective Date	Version	Manufacturing Site	Manufacturing Site		UOM	Unit Type	
	BC858A	BC858AWT1G SS SC70 GF		XSTR PNP 30V		2025-06-04		CN1	CN1		mg	Each	
Manufacturing Proccess Informa	tion		·			•				•			
Terminal Plating / Grid Array Material Terminal Base Allo		Alloy J	-STD-020 MSL	Rating	Peak Proce	ss Body Temp	erature Max Time at Pea	ak Tempera	ature Numb	per of Reflow Cyd	cles		
Matte Tin (Sn) - annealed CU Alloy			1	l		260	С	30	seco	onds 3			
Comments													
level 1 - maximum time at peak temperat	ire during so	Idering is 10-3	0 seconds										
For more information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg	
Lead Frame	2.08	mg	В	Nickel (Ni)	7440-02-0		0.7966	mg	
			Supplier	Iron (Fe)	7439-89-6		1.1003	mg	
			Supplier	Copper (Cu)	7440-50-8		0.183	mg	
Mold Compound-Black	3.7	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.37	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0185	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.5365	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		2.405	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.37	mg	
Plating	0.11	mg	Supplier	Tin (Sn)	7440-31-5		0.11	mg	
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg	